



## ISL9R860PF2

### **Features**

- Stealth Recovery  $t_{rr}$  = 28 ns (@ $I_F$  = 8 A)
- Max Forward Voltage, V<sub>F</sub> = 2.4 V (@ T<sub>C</sub> = 25°C)
- 600 V Reverse Voltage and High Reliability
- · Avalanche Energy Rated
- RoHS compliant

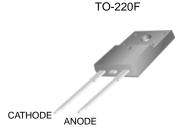
### **Applications**

- · Switch Mode Power Supplies
- · Hard Switched PFC Boost Diode
- · UPS Free Wheeling Diode
- · Motor Drive FWD
- SMPS FWD
- Snubber Diode

## 8 A, 600 V, STEALTH™ Diode

The ISL9R860PF2 is a STEALTHTM diode optimized for low loss performance in high frequency hard switched applications. The STEALTHTM family exhibits low reverse recovery current ( $I_{RM(REC)}$ ) and exceptionally soft recovery under typical operating conditions. This device is intended for use as a free wheeling or boost diode in power supplies and other power switching applications. The low  $I_{RM(REC)}$  and short ta phase reduce loss in switching transistors. The soft recovery minimizes ringing, expanding the range of conditions under which the diode may be operated without the use of additional snubber circuitry. Consider using the STEALTHTM diode with an SMPS IGBT to provide the most efficient and highest power density design at lower cost.

# Package Symbol





### Device Maximum Ratings T<sub>C</sub>= 25°C unless otherwise noted

Symbol	Parameter	Rating	
$V_{RRM}$	Peak Repetitive Reverse Voltage	600	V
V <sub>RWM</sub>	Working Peak Reverse Voltage	600	V
V <sub>R</sub>	DC Blocking Voltage	600	V
I <sub>F(AV)</sub>	Average Rectified Forward Current (T <sub>C</sub> = 75°C)	8	Α
I <sub>FRM</sub>	Repetitive Peak Surge Current (20 kHz Square Wave)	16	Α
I <sub>FSM</sub>	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	100	А
P <sub>D</sub>	Power Dissipation	26	W
E <sub>AVL</sub>	Avalanche Energy (1 A, 40 mH)	20	mJ
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range	-55 to 150	°C
TL	Maximum Temperature for Soldering Leads at 0.063in (1.6 mm) from Case for 10s	300	°C

CAUTION: Stresses above those listed in "Device Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Device Marking Device R860PF2 ISL9R860F		Device	Package Tape Width				Quar	ntity
		ISL9R860PF2	TO-220F	N/A			50 Units	
Electric	cal Char	acteristics T <sub>C</sub> = 25°	C unless otherwise	e noted				
Symbol	Parameter		Test	Test Conditions		Тур	Max	Unit
Off State	Characte	eristics						
I <sub>R</sub>	Instantaneous Reverse Current		V <sub>R</sub> = 600 V	T <sub>C</sub> = 25°C	-	-	100	μΑ
				T <sub>C</sub> = 125°C	-	-	1.0	m/
On State	Characte	eristics						
V <sub>F</sub>	Instantaneous Forward Vo	ous Forward Voltage	I <sub>F</sub> = 8 A	T <sub>C</sub> = 25°C	-	2.0	2.4	V
		v	·	T <sub>C</sub> = 125°C	-	1.6	2.0	V
Oynamic C <sub>J</sub>	Characte Junction C		V <sub>R</sub> = 10V , I <sub>F</sub> =	0 A		30	-	pl
Switchin	g Charac	teristics ecovery Time	I <sub>F</sub> = 1 A, dI <sub>F</sub> /dt =	= 100 A/μs, V <sub>R</sub> = 30 V	_	18	25	ns
"			$I_F = 8 \text{ A}, dI_F/dt =$	$I_F = 8 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$		21	30	ns
t <sub>rr</sub>	Reverse R	ecovery Time	I <sub>F</sub> = 8 A,				-	ns
I <sub>rr</sub>	Maximum I	Reverse Recovery Current		$dI_F/dt = 200 A/\mu s$ ,		3.2	-	Α
Q <sub>rr</sub>	Reverse R	ecovery Charge	$V_{R} = 390 \text{ V, } I_{C}$	$V_R = 390 \text{ V}, T_C = 25^{\circ}\text{C}$			-	n(
t <sub>rr</sub>	Reverse R	ecovery Time	$I_F = 8 A,$	I <sub>F</sub> = 8 A,			-	ns
S	Softness F	actor (t <sub>b</sub> /t <sub>a</sub> )		$dI_F/dt = 200 \text{ A/}\mu\text{s},$		3.7	-	
I <sub>rr</sub>	Maximum I	Reverse Recovery Current	1.	V <sub>R</sub> = 390 V, -T <sub>C</sub> = 125°C			-	Α
$Q_{rr}$	Reverse R	ecovery Charge	10 - 120 0				-	nC
t <sub>rr</sub>	Reverse R	ecovery Time	$I_F = 8 A,$	$I_F = 8 \text{ A},$ $dI_F/dt = 600 \text{ A/}\mu\text{s},$ $V_R = 390 \text{ V},$ $T_C = 125^{\circ}\text{C}$			-	ns
S	Softness F	\ D &/					-	
I <sub>rr</sub>	Maximum I	Reverse Recovery Current					-	Α
$Q_{rr}$		ecovery Charge				195	-	nC
dI <sub>M</sub> /dt	Maximum	di/dt during t <sub>b</sub>			-	500	-	A/k
hermal	Characte	eristics						
$R_{\theta JC}$	Thermal R	esistance Junction to Case			-	-	4.8	°C/
, ,AJC		coloidines sunistion to succ						

## **Typical Performance Curves**

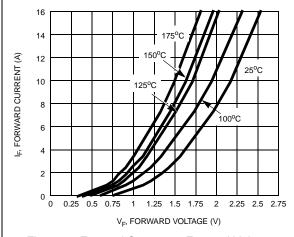
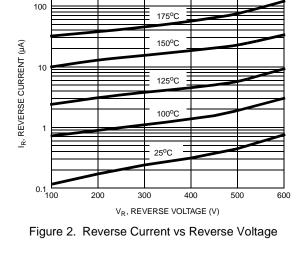


Figure 1. Forward Current vs Forward Voltage



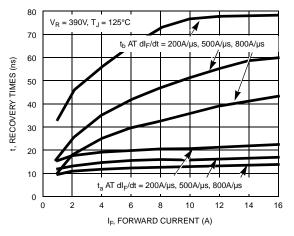


Figure 3.  $t_a$  and  $t_b$  Curves vs Forward Current

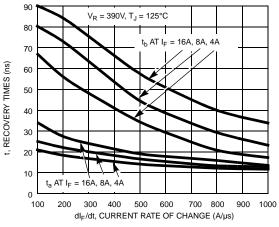


Figure 4.  $t_a$  and  $t_b$  Curves vs  $dI_F/dt$ 

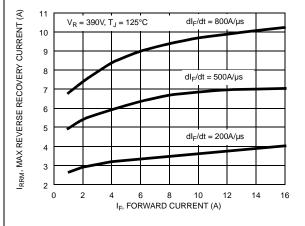


Figure 5. Maximum Reverse Recovery Current vs Forward Current

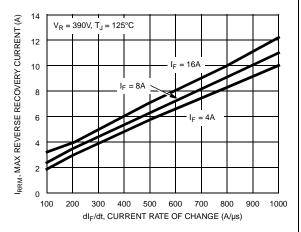
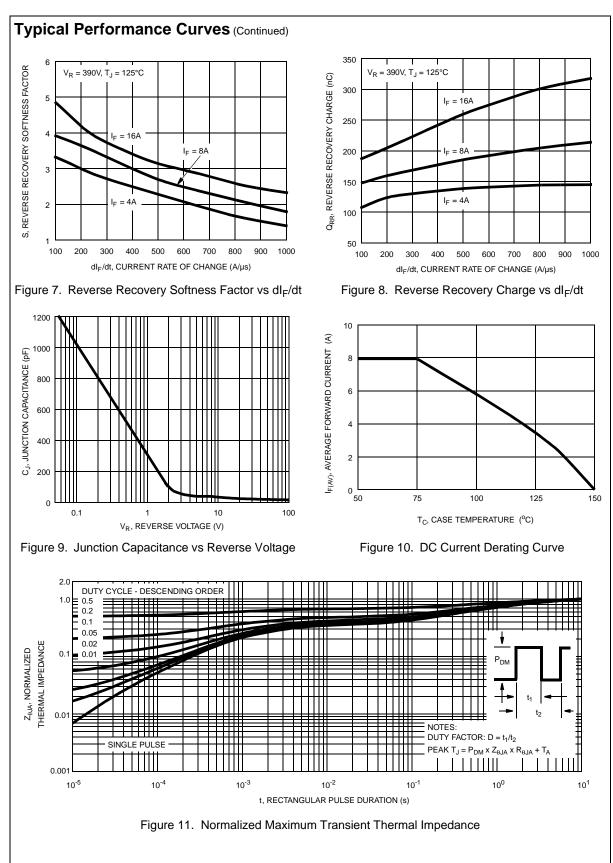
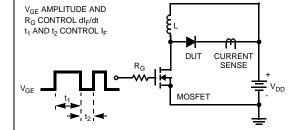


Figure 6. Maximum Reverse Recovery Current vs  $dI_F/dt$ 



## **Test Circuits and Waveforms**



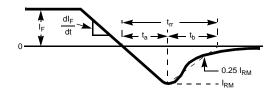


Figure 12. t<sub>rr</sub> Test Circuit

Figure 13. t<sub>rr</sub> Waveforms and Definitions

```
I = 1A
L = 40mH
R < 0.1\Omega
V_{DD} = 50V
E_{AVL} = 1/2LI^2 \left[V_{R(AVL)}/(V_{R(AVL)} - V_{DD})\right]
Q_1 = IGBT \left(BV_{CES} > DUT \ V_{R(AVL)}\right)
L R
CURRENT
SENSE
V_{DD}
U
```

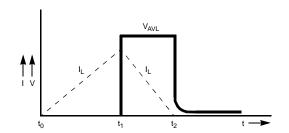


Figure 14. Avalanche Energy Test Circuit

Figure 15. Avalanche Current and Voltage Waveforms



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